In VLSI design, as in life, you have to lay the groundwork if you want to succeed.
Cover

Although the "success" implied by this issue's cover is debatable, the point is clear: Success demands that all of the pieces come together at the right time. In VLSI design, due to the rapid progress of processing technology, one must sometimes start designing chips in anticipation of a new process (the "groundwork") that will not be perfected until months (or even years) later. Cover Illustration by Dick Cole, San Francisco, CA.

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